NX3L2T66 Dual low-ohmic single-pole single-throw analog switch Rev. 7 – 8 February 2013 Product data sheet

# 1. General description

The NX3L2T66 is a dual low-ohmic single-pole single-throw analog switch. Each switch has two input/output terminals (nY and nZ) and an active HIGH enable input (nE). When pin nE is LOW, the analog switch is turned off.

Schmitt trigger action at the enable input (nE) makes the circuit tolerant to slower input rise and fall times. A low input voltage threshold allows pin nE to be driven by lower level logic signals without a significant increase in supply current  $I_{CC}$ . This makes it possible for the NX3L2T66 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation.

The NX3L2T66 allows signals with amplitude up to V<sub>CC</sub> to be transmitted from nY to nZ; or from nZ to nY. Its low ON resistance (0.5  $\Omega$ ) and flatness (0.13  $\Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

# 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 1.6  $\Omega$  (typical) at V<sub>CC</sub> = 1.4 V
  - 1.0  $\Omega$  (typical) at V<sub>CC</sub> = 1.65 V
  - 0.55  $\Omega$  (typical) at V<sub>CC</sub> = 2.3 V
  - 0.50  $\Omega$  (typical) at V<sub>CC</sub> = 2.7 V
  - 0.50  $\Omega$  (typical) at V<sub>CC</sub> = 4.3 V
- High noise immunity
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 7500 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
  - IEC61000-4-2 contact discharge exceeds 4000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- 1.8 V control logic at V<sub>CC</sub> = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V<sub>CC</sub>
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



#### **Applications** 3.

- Cell phone
- PDA
- Portable media player

#### **Ordering information** 4.

#### Table 1. **Ordering information**

Type number	Package	Package							
	Temperature range	Name	Description	Version					
NX3L2T66GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1					
NX3L2T66GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body $3 \times 2 \times 0.5$ mm	SOT996-2					
NX3L2T66GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body $1.6 \times 1.6 \times 0.5$ mm	SOT902-2					

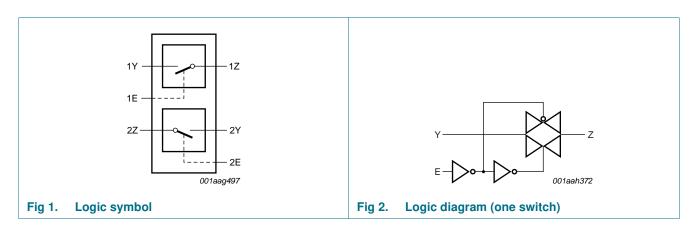
#### Marking 5.

#### Marking codes<sup>[1]</sup> Table 2.

Type number	Marking code
NX3L2T66GT	DOO
NX3L2T66GD	DOO
NX3L2T66GM	DOO

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

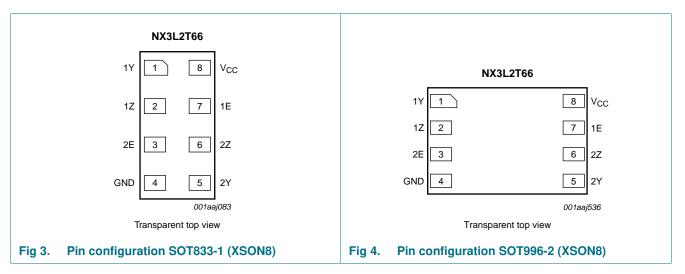
#### **Functional diagram** 6.

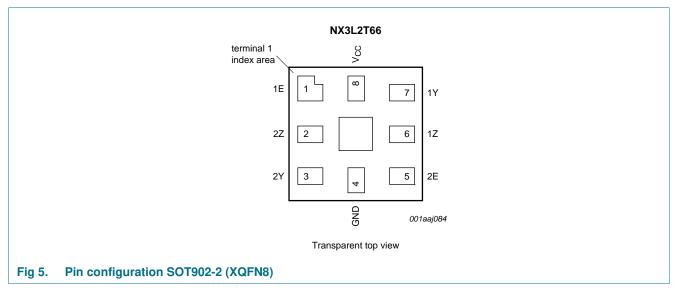


Dual low-ohmic single-pole single-throw analog switch

# 7. Pinning information

# 7.1 Pinning





## 7.2 Pin description

Table 3. Pin description									
Symbol	Pin		Description						
	SOT833-1 and SOT996-2	SOT902-2							
1Y, 2Y	1, 5	7, 3	independent input or output						
1Z, 2Z	2, 6	6, 2	independent input or output						
GND	4	4	ground (0 V)						
1E, 2E	7, 3	1, 5	enable input (active HIGH)						
V <sub>CC</sub>	8	8	supply voltage						

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# 8. Functional description

#### Table 4.Function table<sup>[1]</sup>

Input nE	Switch
L	OFF-state
Н	ON-state

[1] H = HIGH voltage level;

L = LOW voltage level.

# 9. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	٧
VI	input voltage	enable input nE	<u>[1]</u> –0.5	+4.6	٧
V <sub>SW</sub>	switch voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	٧
I <sub>IK</sub>	input clamping current	$V_{l} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	-	±50	mA
I <sub>SW</sub>	switch current	$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; source or sink current	-	±350	mA
		V <sub>SW</sub> > -0.5 V or V <sub>SW</sub> < V <sub>CC</sub> + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON8 and XQFN8 packages: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

# **10. Recommended operating conditions**

#### Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.4	-	4.3	V
VI	input voltage	enable input nE	0	-	4.3	V
V <sub>SW</sub>	switch voltage		<u>[1]</u> 0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$	[2] _	-	200	ns/V

[1] To avoid sinking GND current from terminal nZ when switch current flows in terminal nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nY. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

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### Dual low-ohmic single-pole single-throw analog switch

# **11. Static characteristics**

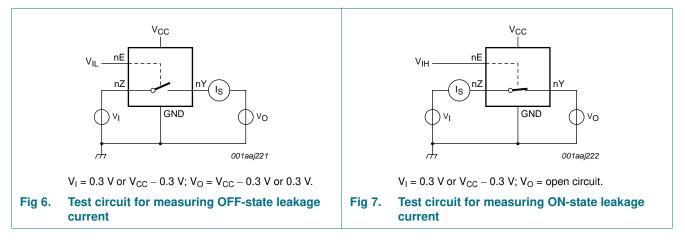
### Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> = -40 °C to +125 °C			Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.4 V to 1.6 V	0.9	-	-	0.9	-	-	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	0.9	-	-	0.9	-	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	-	-	0.4	-	0.4	0.3	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
lı	input leakage current	enable input nE; V <sub>I</sub> = GND to 4.3 V; V <sub>CC</sub> = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μA
I <sub>S(OFF)</sub>	OFF-state	nY port; see <u>Figure 6</u>							
	leakage	$V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	-	±10	-	±50	±500	nA
I <sub>S(ON)</sub>	ON-state	nZ port; see <u>Figure 7</u>							
	leakage	$V_{CC} = 1.4 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nA
	current	$V_{CC} = 3.6 \text{ V} \text{ to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nA
I <sub>CC</sub>	supply current								
		$V_{CC} = 3.6 V$	-	-	100	-	690	6000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	7000	nA
$\Delta I_{CC}$	additional	$V_{SW} = GND \text{ or } V_{CC}$							
	supply current	$V_1 = 2.6 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	2.0	4.0	-	7	7	μA
		$V_1 = 2.6 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	0.35	0.7	-	1	1	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 4.3 \text{ V}$	-	7.0	10.0	-	15	15	μA
		$V_{I} = 1.8 V; V_{CC} = 3.6 V$	-	2.5	4.0	-	5	5	μA
		$V_{I} = 1.8 \text{ V}; V_{CC} = 2.5 \text{ V}$	-	50	200	-	300	500	nA
CI	input capacitance		-	1.0	-	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance		-	35	-	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	110	-	-	-	-	pF

#### Dual low-ohmic single-pole single-throw analog switch

## 11.1 Test circuits



## 11.2 ON resistance

#### Table 8.ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

Symbol	Parameter	Conditions	T <sub>amb</sub>	T <sub>amb</sub> = −40 °C to +85 °C			-40 °C to 5 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA};$ see <u>Figure 8</u>						
		$V_{CC} = 1.4 V$	-	1.6	3.7	-	4.1	Ω
		V <sub>CC</sub> = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 V$	-	0.55	0.8	-	0.9	Ω
		$V_{CC} = 2.7 V$	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω
$\Delta R_{ON}$	ON resistance mismatch between channels	$V_I = GND$ to $V_{CC}$ ; $I_{SW} = 100 \text{ mA}$	[2]					
		$V_{CC} = 1.4 V$	-	0.04	0.3	-	0.3	Ω
		V <sub>CC</sub> = 1.65 V	-	0.04	0.2	-	0.3	Ω
		$V_{CC} = 2.3 V$	-	0.02	0.08	-	0.1	Ω
		$V_{CC} = 2.7 V$	-	0.02	0.075	-	0.1	Ω
		$V_{CC} = 4.3 V$	-	0.02	0.075	-	0.1	Ω

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#### Dual low-ohmic single-pole single-throw analog switch

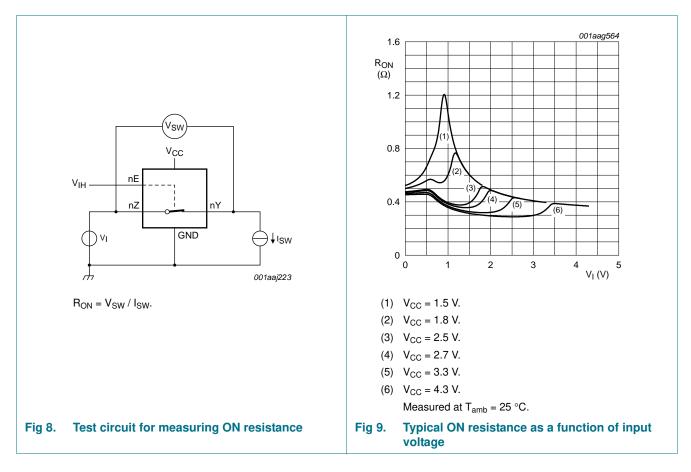
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see <u>Figure 9</u> to <u>Figure 15</u> .										
Symbol	Parameter	Conditions T <sub>an</sub>		T <sub>amb</sub> = -40 °C to +85 °C			T <sub>amb</sub> = −40 °C to +125 °C			
	Min	Typ <mark>[1]</mark>	Max	Min	Max					
R <sub>ON(flat)</sub> ON resistance (fla	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ [3] $I_{SW} = 100 \text{ mA}$								
		$V_{CC} = 1.4 V$	-	1.0	3.3	-	3.6	Ω		
		V <sub>CC</sub> = 1.65 V	-	0.5	1.2	-	1.3	Ω		
		$V_{CC} = 2.3 V$	-	0.15	0.3	-	0.35	Ω		
		$V_{CC} = 2.7 V$	-	0.13	0.3	-	0.35	Ω		
		$V_{CC} = 4.3 V$	-	0.2	0.4	-	0.45	Ω		

#### Table 8. **ON resistance** ... continued

[1] Typical values are measured at  $T_{amb} = 25 \ ^{\circ}C$ .

Measured at identical  $V_{\text{CC}},$  temperature and input voltage. [2]

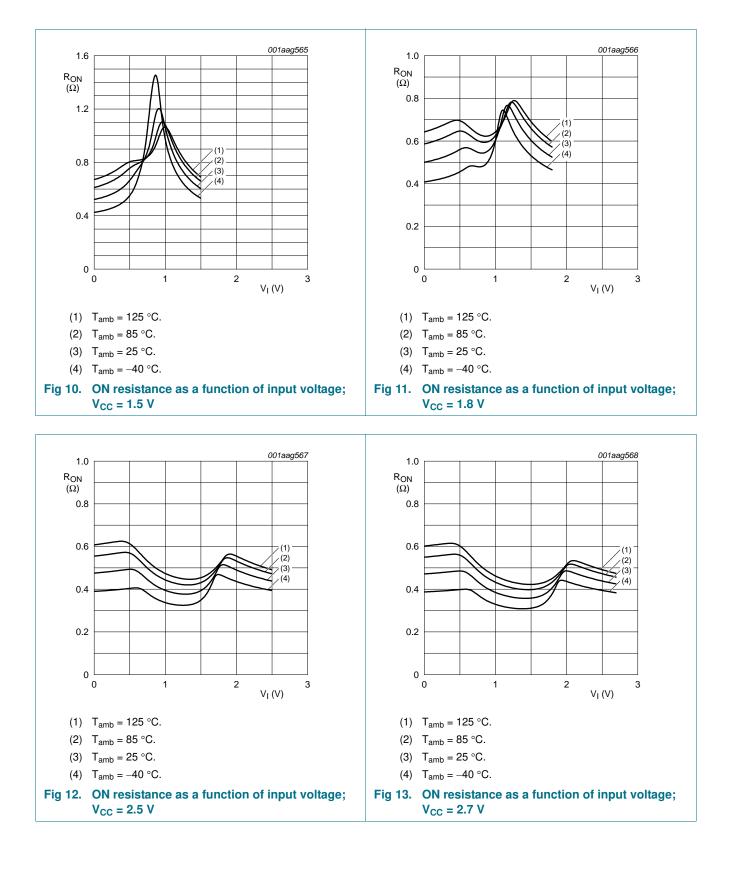
Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and [3] temperature.



# 11.3 ON resistance test circuit and graphs

# NX3L2T66

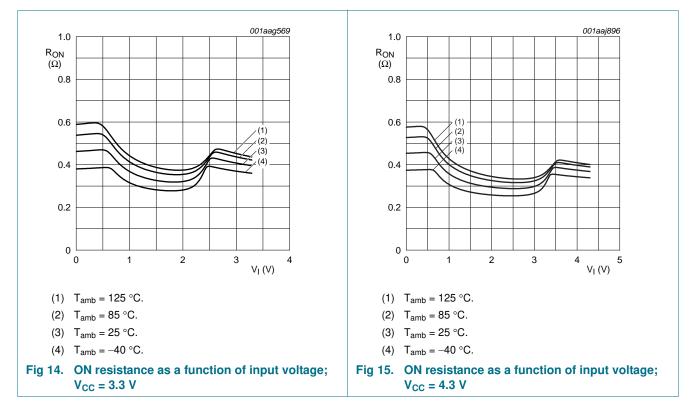
### Dual low-ohmic single-pole single-throw analog switch



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# NX3L2T66

### Dual low-ohmic single-pole single-throw analog switch



# 12. Dynamic characteristics

#### Table 9. Dynamic characteristics

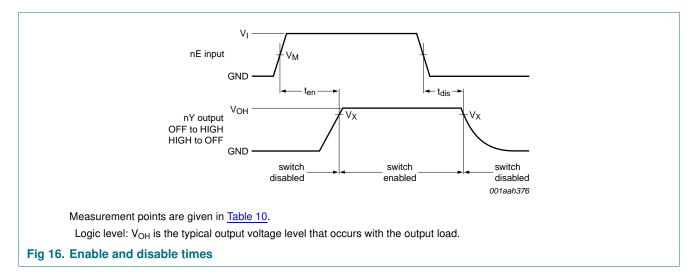
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

Symbol	Parameter	Conditions	Ta	<sub>mb</sub> = 25	°C	T <sub>amb</sub> =	–40 °C to	+125 °C	Unit
			Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
t <sub>en</sub>	enable time	nE to nZ or nY; see <u>Figure 16</u>							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$	-	35	49	-	53	57	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	28	40	-	43	48	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	20	30	-	32	35	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	18	28	-	30	32	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	18	28	-	30	32	ns
t <sub>dis</sub>	disable time	nE to nZ or nY; see <u>Figure 16</u>							
		$V_{CC} = 1.4 V$ to 1.6 V	-	32	70	-	80	90	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	23	55	-	60	65	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$	-	14	25	-	30	35	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	11	20	-	25	30	ns
		$V_{CC} = 3.6 V \text{ to } 4.3 V$	-	11	20	-	25	30	ns

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

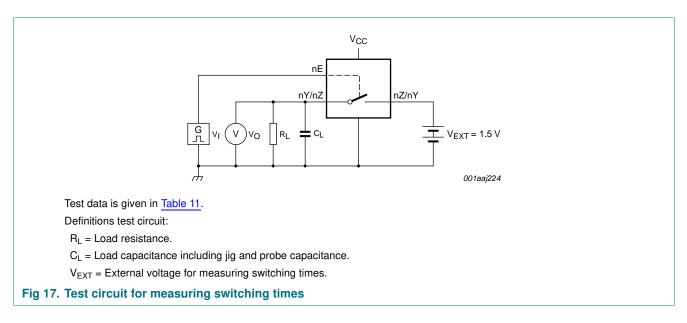
#### Dual low-ohmic single-pole single-throw analog switch

# 12.1 Waveform and test circuits



#### Table 10.Measurement points

Supply voltage	Input	Output
V <sub>cc</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>



#### Table 11. Test data

Supply voltage	Input		Load	
V <sub>cc</sub>	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL
1.4 V to 4.3 V	V <sub>CC</sub>	≤ 2.5 ns	35 pF	50 Ω

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#### Dual low-ohmic single-pole single-throw analog switch

## 12.2 Additional dynamic characteristics

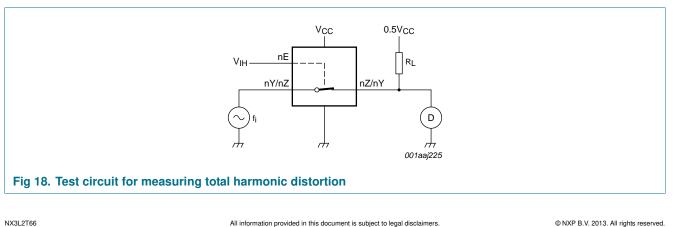
#### Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_1 = GND$  or  $V_{CC}$  (unless otherwise specified);  $t_r = t_f \le 2.5 \text{ ns.}$ 

Symbol	Parameter	Conditions	T <sub>amb</sub> = 25 °C			Unit	
				Min	Тур	Max	-
THD	total harmonic distortion	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 18}{1000 \text{ sec } 18}$	[1]				
		V <sub>CC</sub> = 1.4 V; V <sub>I</sub> = 1 V (p-p)		-	0.15	-	%
		V <sub>CC</sub> = 1.65 V; V <sub>I</sub> = 1.2 V (p-p)		-	0.10	-	%
		V <sub>CC</sub> = 2.3 V; V <sub>I</sub> = 1.5 V (p-p)		-	0.02	-	%
		V <sub>CC</sub> = 2.7 V; V <sub>I</sub> = 2 V (p-p)		-	0.02	-	%
		V <sub>CC</sub> = 4.3 V; V <sub>I</sub> = 2 V (p-p)		-	0.02	-	%
f <sub>(-3dB)</sub>	-3 dB frequency	$R_L = 50 \Omega$ ; see <u>Figure 19</u>	[1]				
	response	V <sub>CC</sub> = 1.4 V to 4.3 V		-	60	-	MHz
$\alpha_{\text{iso}}$	isolation (OFF-state)	$f_i = 100 \text{ kHz}; \text{ R}_L = 50 \Omega; \text{ see } \frac{\text{Figure 20}}{100 \text{ kHz}}$	[1]				
		$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$		-	-90	-	dB
V <sub>ct</sub>	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 21					
		V <sub>CC</sub> = 1.4 V to 3.6 V		-	0.2	-	V
		V <sub>CC</sub> = 3.6 V to 4.3 V		-	0.2	-	V
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$ ; $R_L = 50 \Omega$ ; see Figure 22	<u>[1]</u>				
		V <sub>CC</sub> = 1.4 V to 4.3 V		-	-90	-	dB
Q <sub>inj</sub>	charge injection	$f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; see Figure 23$					
		$V_{CC} = 1.5 V$		-	3	-	рС
		V <sub>CC</sub> = 1.8 V		-	3	-	рС
		$V_{CC} = 2.5 V$		-	3	-	рС
		$V_{CC} = 3.3 V$		-	3	-	рС
		$V_{CC} = 4.3 V$		-	6	-	рС

[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

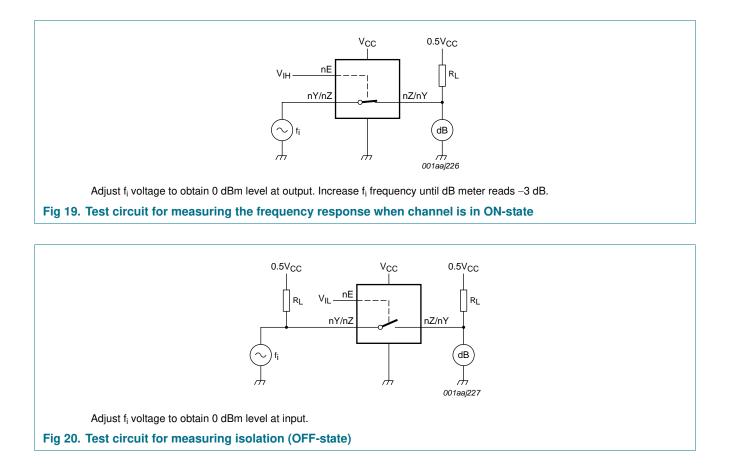
## 12.3 Test circuits



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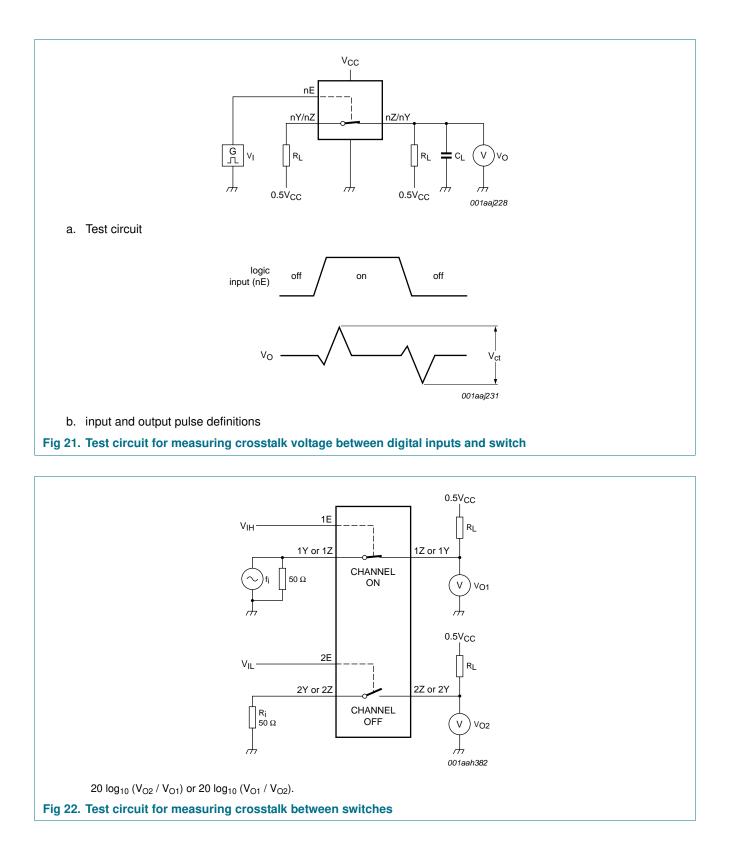
# NX3L2T66

Dual low-ohmic single-pole single-throw analog switch



# NX3L2T66

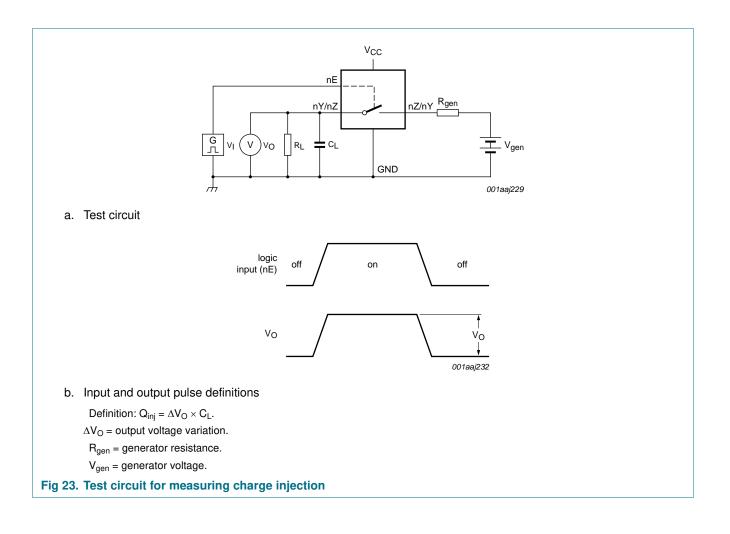
Dual low-ohmic single-pole single-throw analog switch



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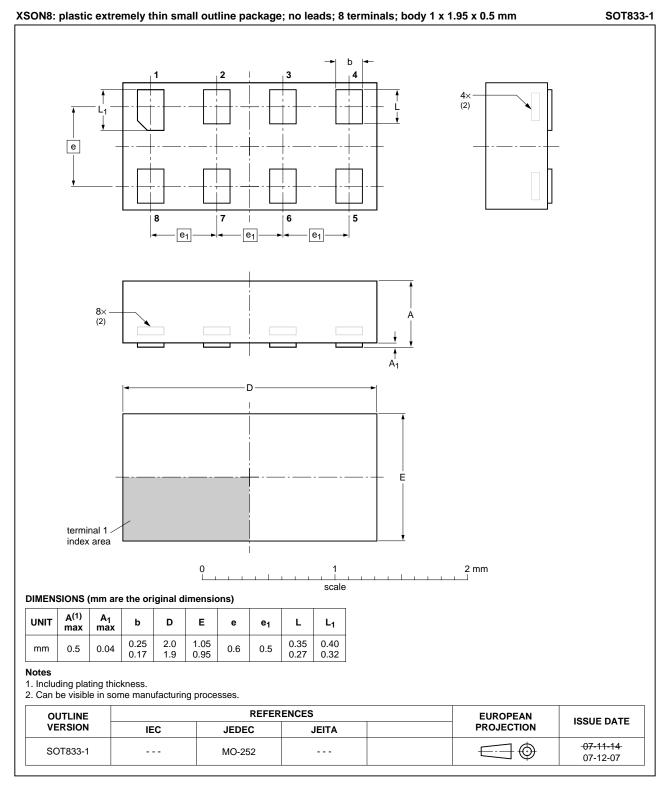
# NX3L2T66

### Dual low-ohmic single-pole single-throw analog switch



#### Dual low-ohmic single-pole single-throw analog switch

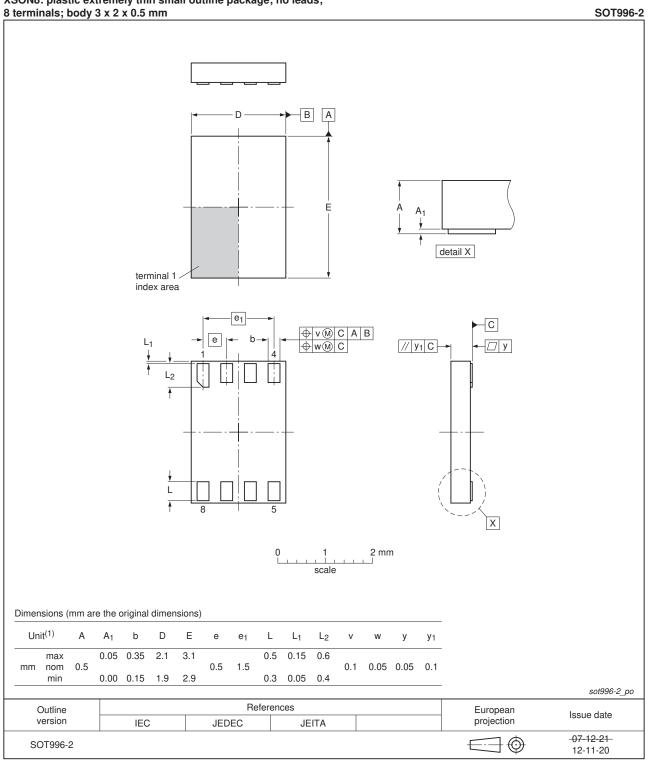
# 13. Package outline



### Fig 24. Package outline SOT833-1 (XSON8)

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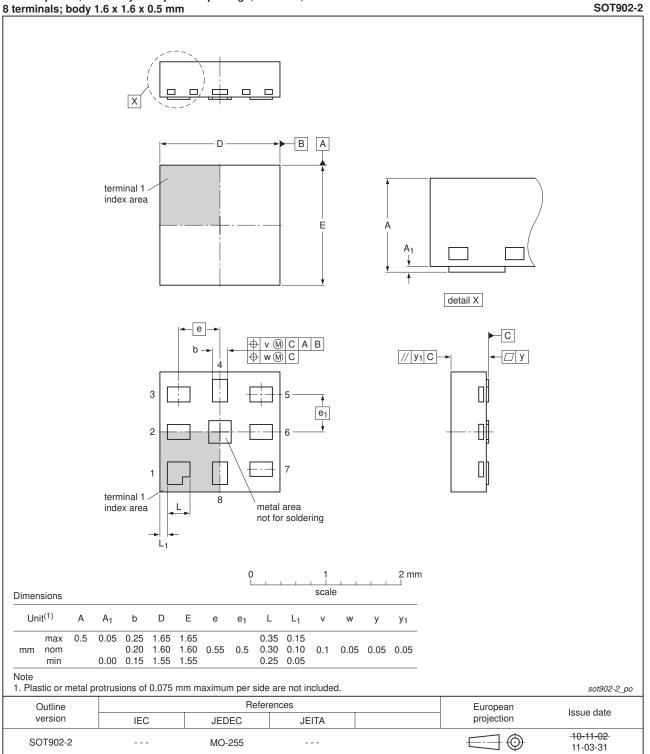


XSON8: plastic extremely thin small outline package; no leads;

Fig 25. Package outline SOT996-2 (XSON8)

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Dual low-ohmic single-pole single-throw analog switch



XQFN8: plastic, extremely thin quad flat package; no leads;

#### Fig 26. Package outline SOT902-2 (XQFN8)

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# 14. Abbreviations

Table 13.	Abbreviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant
-	

# 15. Revision history

Table 14. Revision his	story			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L2T66 v.7	20130208	Product data sheet	-	NX3L2T66 v.6
Modifications:	<ul> <li>For type nur</li> </ul>	nber NX3L2T66GD XSON8	U has changed to XSO	N8.
NX3L2T66 v.6	20120606	Product data sheet	-	NX3L2T66 v.5
NX3L2T66 v.5	20111107	Product data sheet	-	NX3L2T66 v.4
NX3L2T66 v.4	20101229	Product data sheet	-	NX3L2T66 v.3
NX3L2T66 v.3	20090828	Product data sheet	-	NX3L2T66 v.2
NX3L2T66 v.2	20090420	Product data sheet	-	NX3L2T66 v.1
NX3L2T66 v.1	20081204	Product data sheet	-	-

# 16. Legal information

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[2] The term 'short data sheet' is explained in section "Definitions".

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#### Dual low-ohmic single-pole single-throw analog switch

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